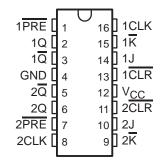
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- Inputs Are TTL-Voltage Compatible
- Flow-Through Architecture Optimizes
 PCB Layout
- Center-Pin V_{CC} and GND Configurations Minimize High-Speed Switching Noise
- EPIC[™] (Enhanced-Performance Implanted CMOS) 1-μm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic Small-Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs

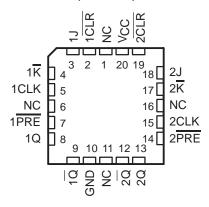
description

These devices contain two independent J- \overline{K} positive-edge-triggered flip-flops. A low level at the preset (1PRE or 2PRE) or clear (1CLR or 2CLR) input sets or resets the outputs regardless of the levels of the other inputs. When PRE and $\overline{\text{CLR}}$ are inactive (high), data at the J and $\overline{\text{K}}$ inputs meeting the setup time requirements are transferred to the outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold-time interval, data at the J and \overline{K} inputs may be changed without affecting the levels at the outputs. These versatile flip-flops can perform as toggle flip-flops by grounding \overline{K} and tying J high. They also can perform as D-type flip-flops if J and K are tied together.

54ACT11109 ... J PACKAGE 74ACT11109 ... D OR N PACKAGE (TOP VIEW)



54ACT11109 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

The 54ACT11109 is characterized for operation over the full military temperature range of -55° C to 125° C. The 74ACT11109 is characterized for operation from -40° C to 85° C.

FUNCTION TABLE

		INPUTS			OUTI	PUTS	
PRE	CLR	CLK	J	K	Q	Q	
L	Н	Х	Х	Х	Н	L	
Н	L	X	Χ	X	L	Н	
L	L	X	Χ	Χ	H [†]	H [†]	
Н	Н	\uparrow	L	L	L	Н	
Н	Н	\uparrow	Н	L	Toggle		
Н	Н	\uparrow	L	Н	Q_0	\overline{Q}_0	
Н	Н	\uparrow	Н	Н	Н	L	
Н	Н	L	Χ	X	Q_0	\overline{Q}_0	

[†] This configuration is nonstable; that is, it will not persist when either PRE or CLR returns to the inactive (high) level.

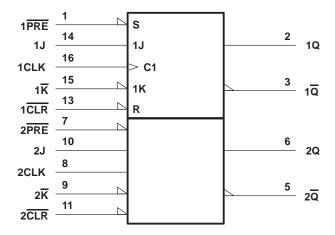
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54ACT11109, 74ACT11109 DUAL J-K POSITIVE-EDGE-TRIGGERED FLIP-FLOPS WITH CLEAR AND PRESET

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logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, and N packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V _{CC}	0.5 V to 6 V
Input voltage range, V _I (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Output voltage range, V _O (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	±50 mA
Continuous current through V _{CC} or GND	±100 mA
Storage temperature range	–65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		54ACT11109		74ACT	UNIT	
		MIN	MAX	MIN	MAX	UNII
VCC	Supply voltage	4.5	5.5	4.5	5.5	V
V_{IH}	High-level input voltage	2		2		V
VIL	Low-level input voltage		0.8		0.8	V
VI	Input voltage	0	VCC	0	VCC	V
VO	Output voltage	0	VCC	0	VCC	V
loh	High-level output current		-24		-24	mA
loL	Low-level output current		24		24	mA
Δt/Δν	Input transition rise or fall rate	0	10	0	10	ns/V
TA	Operating free-air temperature	-55	125	-40	85	°C



NOTE 1: The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	Vaa	T _A = 25°C			54ACT11109		74ACT11109		UNIT
PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	ONII
	ΙΟΗ = – 50 μΑ	4.5 V	4.4			4.4		4.4		
		5.5 V	5.4			5.4		5.4		
\/a	lou - 24 mA	4.5 V	3.94			3.7		3.8		.,
VOH	$I_{OH} = -24 \text{ mA}$	5.5 V	4.94			4.7		4.8		V
	I _{OH} = -50 mA [†]	5.5 V				3.85				
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V						3.85		
	Ι _{ΟL} = 50 μΑ	4.5 V			0.1		0.1		0.1	V
		5.5 V			0.1		0.1		0.1	
\/a:	I _{OL} = 24 mA	4.5 V			0.36		0.5		0.44	
VOL		5.5 V			0.36		0.5		0.44	
	I _{OL} = 50 mA [†]	5.5 V					1.65			
	I _{OL} = 75 mA [†]	5.5 V							1.65	
lį	V _I = V _{CC} or GND	5.5 V			±0.1		±1		±1	μΑ
lcc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			4		80		40	μΑ
∆lCC [‡]	One input at 3.4 V, Other inputs at V _{CC} or GND	5.5 V			0.9		1		1	mA
Ci	$V_I = V_{CC}$ or GND	5 V		3.5						pF

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

		T _A = 25°C		54ACT11109		74ACT11109		UNIT	
			MIN	MAX	MIN	MAX	MIN	MAX	UNIT
fclock	Clock frequency		0	100	0	100	0	100	MHz
	Pulse duration	PRE or CLR low	5.5		5.5		5.5		ns
t _W		CLK high or low	5		5		5		
	Catura time a hadana CLIVA	Data high or low	5.5		5.5		5.5		
t _{su}	Setup time before CLK↑	PRE or CLR inactive	2		2		2		ns
t _h	Hold time, data after CLK↑		0	·	0	·	0		ns

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	T _A = 25°C			54ACT11109		74ACT11109		UNIT
PARAMETER			MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
f _{max}			100	125		100		100		MHz
t _{PLH}	PRE or CLR	Q or Q	1.5	5.5	8.6	1.5	9.8	1.5	9.2	
tPHL			1.5	6	10.8	1.5	12.6	1.5	11.8	ns
t _{PLH}	CLK	Q or Q	1.5	6	8.3	1.5	9.7	1.5	9.1	ns
t _{PHL}	CLK	Q OI Q	1.5	5.5	7.6	1.5	9	1.5	8.3	115

[‡] This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V_{CC}.

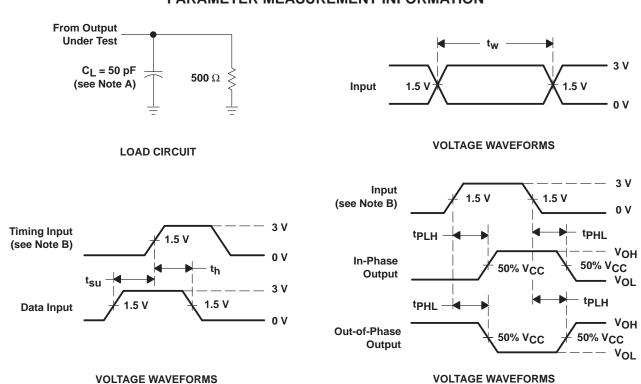
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operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER		TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance per flip-flop	$C_L = 50 \text{ pF}, f = 1 \text{ MHz}$	31	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_0 = 50 \Omega$, $t_f = 3 \text{ ns}$, $t_f = 3 \text{ ns}$.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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